## Spring Loaded Contacts With PRECI-DIP Integrated CLIP ±.002] [.061±.002] ±.002] 1.55 ±0.05 1.62 ±0.05 [.061±.002<sup>-</sup> 1.55 ±0.05 1.07 ±0.05 **Rigid Sliding** Piston [.064 [.042 [030] 0.77 Flexible Multi-Finger θ Ø Φ Ð Contact point Elastic Clip [.072 ±.003] 1.83 ±0.07 Fixed Body Φ 0.57 ±0.05 $[.022 \pm .002]$ 0.5 ±0.05 NOTES: $[.020 \pm .002]$ MECHANICAL REQUIREMENTS: Durability: 20'000 cycles Working stroke between H1 and H2 : S= 1.4 mm [.055'] Spring forces (F): Finit= 0.50 N at Hinit= 8.55 mm [.336'] F1= 0.57 N at H1= 8.35 mm [.328'] Fnom= 0.82±0.15 N at Hnom= 7.65 mm [.301'] 5 ±0.1 F2= 1.0 N at H2= 6.95 mm [.276'] [.197 ±.004] Recommended working range: between H1 and H2 Forces are measured in mean value of compression / decompression ELECTRICAL REQUIREMENTS: 8.55 ±0.1 Contact resistance: R= 30 mOhms max in static mode at Hnom [.337 ±.004] Current per individual contact in free air at ambient temperature: ICont= 5 A at Hnom with temperature raise max 30°C ENVIRONMENTAL REQUIREMENTS: Operating temperature: -25 °C / +125 °C Storage temperature: -40 °C / +125 °C Relative humidity: 5% / 95% MATERIALS / PLATINGS: 0907-4-CLIP //90646-AS Series 0900-CLIP Contact interfaces plated with 0.5 µm (20µ') gold over Nickel Spring: Stainless steel Remplacé par: Clip : Beryllium Copper High Reliability 24.09.2020 Dessiné C.Bidault SOLDERING : 25:1 Spring Loaded Conntact Recommanded PCB pad size : 2.0 mm [.078'] Contrôlé Solderability J-STD-002A. Test A 245°C, 5s, solder alloy SnAg3.8Cu0.7 Resistance to soldering heat J-STD-020C, 260°C, 20S preci-dip N° dessin Révision **INSULATOR** : If assembling pin into moulding : Recommanded hole size : Ø1.58[.062'] P1 0907-4-CLIP swiss world connects